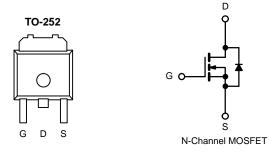


## FR18N15D-VB Datasheet

## N-Channel 150 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
150	0.074 at V <sub>GS</sub> = 10 V	25.4	23 nC			
150	0.077 at V <sub>GS</sub> = 8 V	22.5	23110			



#### FEATURES

- Halogen-free According to IEC 61249-2-21
   Definition
- Extremely Low Q<sub>gd</sub> for Switching Losses
- 100 % R<sub>g</sub> Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

• Primary Side Switch



HALOGEN

Available

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	150	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	V
	T <sub>C</sub> = 25 °C		25.4	
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C		23.1	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	15.5 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		14.5 <sup>b, c</sup>	Α
Pulsed Drain Current		I <sub>DM</sub>	50	A
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		4.5	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.6 <sup>b, c</sup>	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20	
Single Pulse Avalanche Energy		E <sub>AS</sub>	20	mJ
	T <sub>C</sub> = 25 °C		5.9	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	Ъ	3.8	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.1 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C		2 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
	Symbol	Typical	Maximum	Unit			
t ≤ 10 s	R <sub>thJA</sub>	33	40	°C/W			
Steady State	R <sub>thJF</sub>	17	21				
	t ≤ 10 s	Symbol           t ≤ 10 s         R <sub>thJA</sub>	Symbol         Typical           t ≤ 10 s         R <sub>thJA</sub> 33	Symbol         Typical         Maximum           t ≤ 10 s $R_{thJA}$ 33         40			

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	· ·						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	150			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L _ 250 uA		172		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 10		mv/ C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.5		3.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Currant		$V_{DS} = 150 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
Drain-Source On-State Resistance <sup>a</sup>	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A	0.074			Ω	
	R <sub>DS(on)</sub>	$V_{GS} = 8 V, I_{D} = 5 A$		0.077		52	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5 A		23		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			1735		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 50 V, $V_{GS}$ = 0 V, f = 1 MHz		160			
Reverse Transfer Capacitance	C <sub>rss</sub>			37			
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 75$ V, $V_{GS} = 10$ V, $I_{D} = 5$ A		28.5	43	nC	
Total Gate Charge				23	35		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 75 V, $V_{GS}$ = 8 V, $I_{D}$ = 5 A		8			
Gate-Drain Charge	Q <sub>gd</sub>			6.5			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.85	1.3	Ω	
Turn-on Delay Time	t <sub>d(on)</sub>			14	21		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 10 $\Omega$		12	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	${ m I}_{ m D}\cong$ 5 A, ${ m V}_{ m GEN}$ = 10 V, ${ m R}_{ m g}$ = 1 $\Omega$		22	33		
Fall Time	t <sub>f</sub>			6	10	ns	
Turn-On Delay Time	t <sub>d(on)</sub>			16	24	115	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 10 $\Omega$		12	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, \text{ V}_{\text{GEN}} = 8 \text{ V}, \text{ R}_g = 1 \Omega$		20	30		
Fall Time	t <sub>f</sub>			7	12		
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			7.7	А	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2.6 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			63	95	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 5 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		110	165	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$F = 5 A$ , $u/u = 100 A/\mu s$ , $T_{J} = 25 C$		49		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			14			

Notes:

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$ 

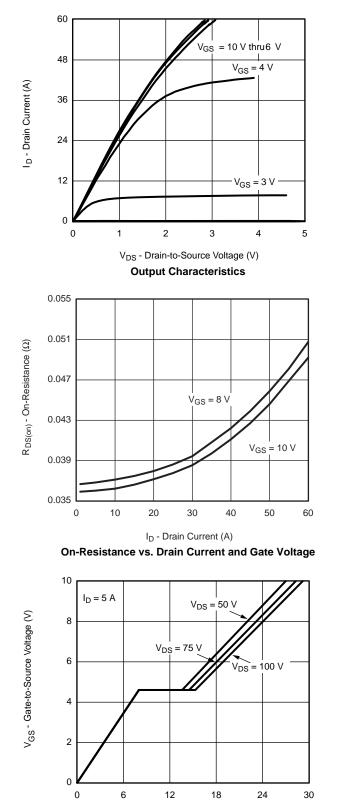
a. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Bsemi

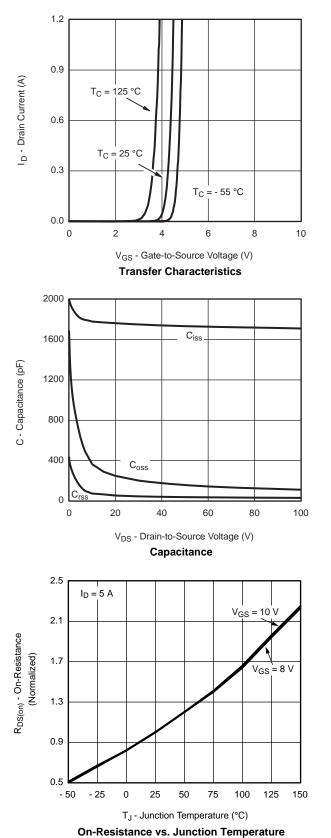
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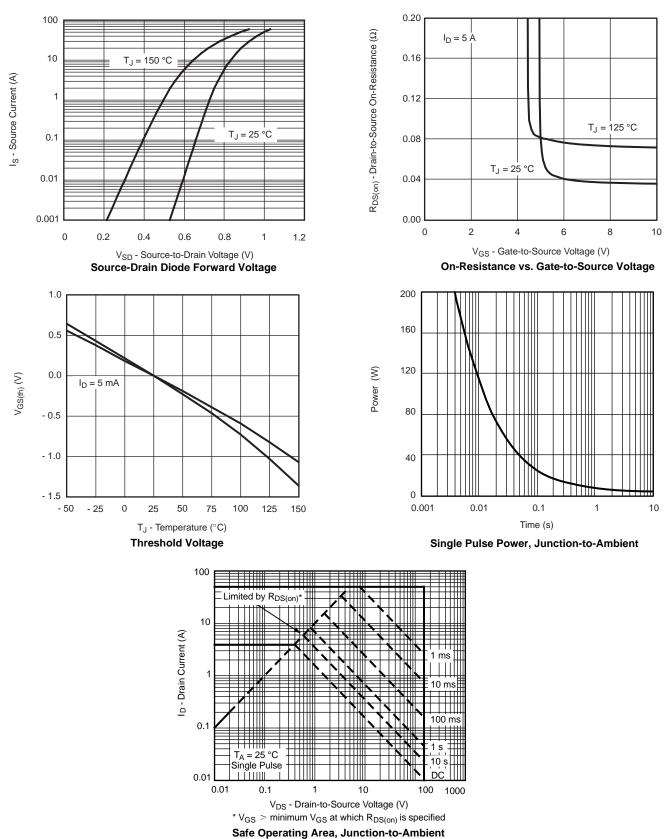


Q<sub>g</sub> - Total Gate Charge (nC) Gate Charge

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





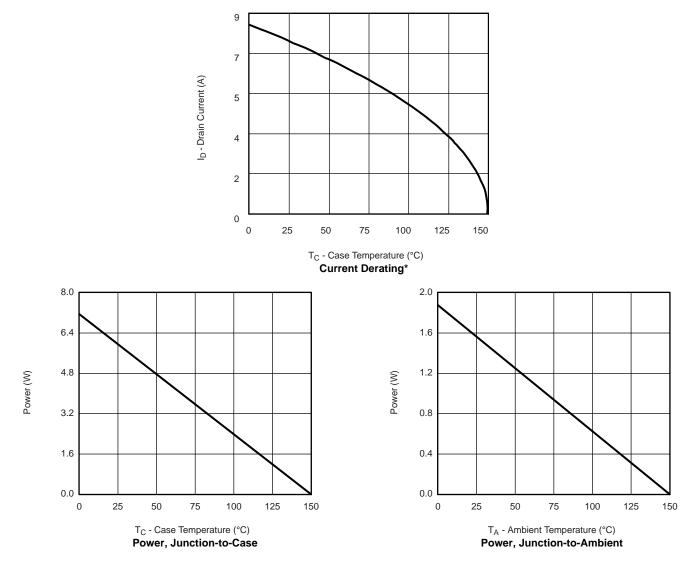


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





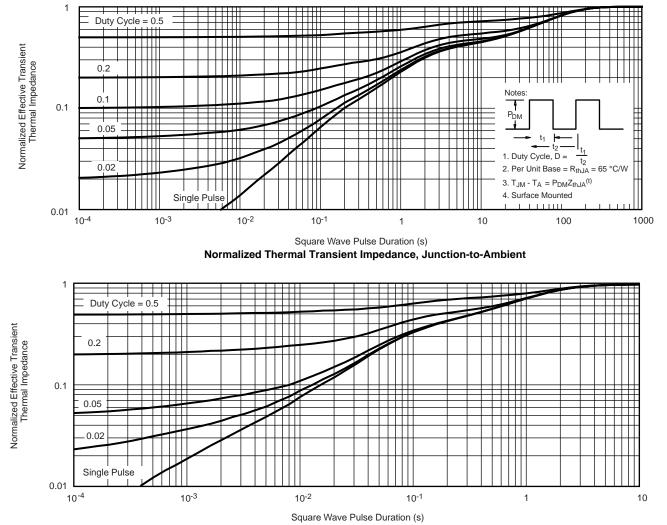
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



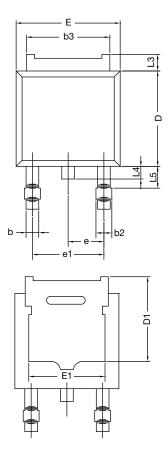
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot



## **TO-252AA CASE OUTLINE**





	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	5.21	-	0.205	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
е	2.28	BSC 0.090 BS		BSC
e1	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.14	1.52	0.045	0.060
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347				

#### Note

• Dimension L3 is for reference only.



#### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)



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